## **LISTING OF THE CLAIMS:**

Claims 1-23 (previously withdrawn)

Claim 24. (currently amended) A poly-poly capacitor comprising <u>planar</u> upper and lower plate electrodes, wherein at least the <u>planar</u> upper plate electrode is composed of SiGe polysilicon, said plate electrodes being separated by an insulator structure and said <u>planar</u> upper plate electrode is located directly above said insulator structure and said lower plate electrode is located directly below said insulator structure.

Claim 25. (previously amended) The poly-poly capacitor of Claim 24 wherein the lower plate electrode is composed of polysilicon.

Claim 26. (currently amended) A poly-poly capacitor comprising <u>planar</u> upper and lower plate electrodes, wherein the <u>planar</u> upper plate electrode and the lower plate electrode are both composed of SiGe polysilicon, said plate electrodes being separated by an insulator structure.

Claim 27. (original) The poly-poly capacitor of Claim 24 wherein at least one said plate electrodes is polysilicon from a FET gate or a bipolar emitter.

Claim 28. (original) The poly-poly capacitor of Claim 24 further including a bipolar device region and a FET region, wherein said capacitor, bipolar device region and FET region are electrically isolated from each by isolation regions.

Claim 29. (original) A semiconductor device, comprising:

a capacitor having first and second plate electrodes, one of said plate electrodes being comprised of a first conductive patterned layer; and

a bipolar device having first and second electrodes, one of said electrodes being comprised of said conductive patterned layer;

wherein said first conductive patterned layer is comprised of SiGe material.

Claim 30. (previously amended) A semiconductor structure, comprising

a first layer of polysilicon patterned to form a first electrode of a MOS device and a first plate electrode of a capacitor, and

a second layer of polysilicon patterned to form a first electrode of a bipolar device and a second plate electrode of said capacitor, said second layer being comprised of SiGe polysilicon.